## MMSZ4xxxET1G Series, SZMMSZ4xxxET1G Series

# Zener Voltage Regulators

### 500 mW SOD-123 Surface Mount

Three complete series of Zener diodes are offered in the convenient, surface mount plastic SOD-123 package. These devices provide a convenient alternative to the leadless 34-package style.

#### Features

- 500 mW Rating on FR-4 or FR-5 Board
- Wide Zener Reverse Voltage Range 1.8 V to 43 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Peak Power 225 W (8 x 20 µs)
- AEC-Q101 Qualified and PPAP Capable
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- Pb-Free Packages are Available\*

#### **Mechanical Characteristics:**

**CASE:** Void-free, transfer-molded, thermosetting plastic case **FINISH:** Corrosion resistant finish, easily solderable

# **MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:** 260°C for 10 Seconds

**POLARITY:** Cathode indicated by polarity band **FLAMMABILITY RATING:** UL 94 V-0

#### MAXIMUM RATINGS

Rating	Symbol	Мах	Unit
Peak Power Dissipation @ 20 μs (Note 1) @ T <sub>L</sub> ≤ 25°C	P <sub>pk</sub>	225	W
Total Power Dissipation on FR–5 Board, (Note 2) @ T <sub>L</sub> = 75°C Derated above 75°C	P <sub>D</sub>	500 6.7	mW mW/°C
Thermal Resistance, (Note 3) Junction-to-Ambient	$R_{\thetaJA}$	340	°C/W
Thermal Resistance, (Note 3) Junction-to-Lead	$R_{\theta JL}$	150	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Nonrepetitive current pulse per Figure 11.

- 2. FR-5 =  $3.5 \times 1.5$  inches, using the minimum recommended footprint.
- 3. Thermal Resistance measurement obtained via infrared Scan Method.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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SOD-123 CASE 425 STYLE 1



#### MARKING DIAGRAM



xxx = Device Code (Refer to page 2)

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMSZ4xxxET1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SZMMSZ4xxxET1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
MMSZ4xxxET3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

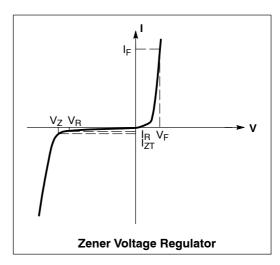
#### **DEVICE MARKING INFORMATION**

See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

### MMSZ4xxxET1G Series, SZMMSZ4xxxET1G Series

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted, V<sub>F</sub> = 0.95 V Max. @ I<sub>F</sub> = 10 mA)

Symbol	Parameter			
VZ	Reverse Zener Voltage @ I <sub>ZT</sub>			
I <sub>ZT</sub>	Reverse Current			
I <sub>R</sub>	Reverse Leakage Current @ VR			
V <sub>R</sub>	Reverse Voltage			
١ <sub>F</sub>	Forward Current			
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>			



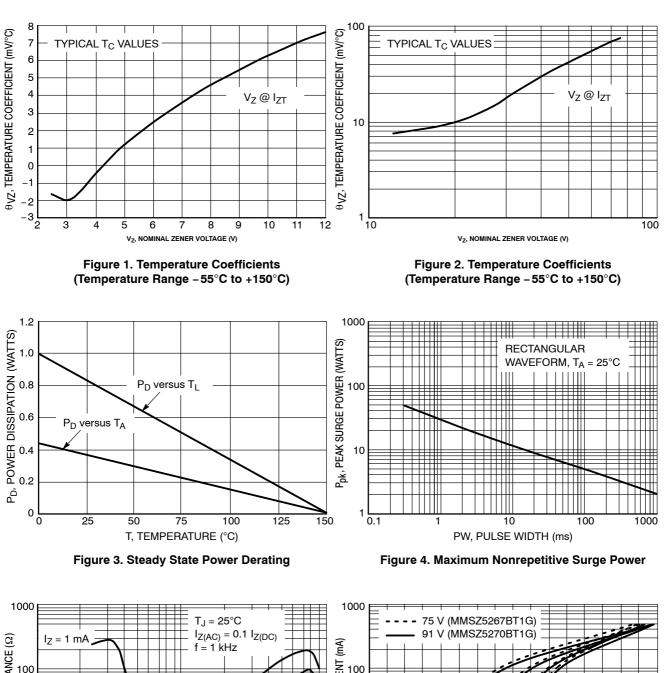
#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted, V<sub>F</sub> = 0.9 V Max. @ I<sub>F</sub> = 10 mA)

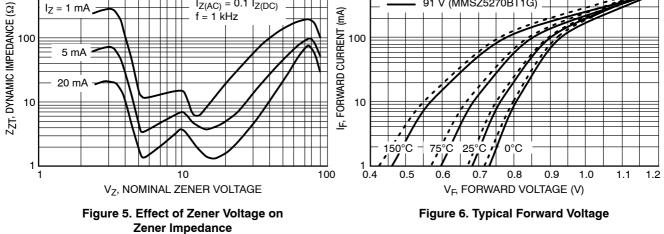
		Zener Voltage (Note 1)				Leakage Current		
	Device	Vz (V)			@ I <sub>ZT</sub>		I <sub>R</sub> @ V <sub>R</sub>	
	Marking	Min	Nom	Max	μA	μΑ	v	
MMSZ4680ET1G	CF8	2.09	2.2	2.31	50	4	1	
MMSZ4684ET1G	CG3	3.13	3.3	3.47	50	7.5	1.5	
MMSZ4688ET1G	CG7	4.47	4.7	4.94	50	10	3	
MMSZ4689ET1G	CG8	4.85	5.1	5.36	50	10	3	
MMSZ4690ET1G	CG9	5.32	5.6	5.88	50	10	4	
MMSZ4691ET1G	CH1	5.89	6.2	6.51	50	10	5	
MMSZ4692ET1G	CH2	6.46	6.8	7.14	50	10	5.1	
MMSZ4693ET1G	СНЗ	7.13	7.5	7.88	50	10	5.7	
MMSZ4697ET1G	CH7	9.50	10	10.50	50	1	7.6	
MMSZ4699ET1G	CH9	11.40	12	12.60	50	0.05	9.1	
MMSZ4701ET1G	CJ2	13.3	14	14.7	50	0.05	10.6	
MMSZ4702ET1G	CJЗ	14.25	15	15.75	50	0.05	11.4	
MMSZ4703ET1G	CJ4	15.20	16	16.80	50	0.05	12.1	
MMSZ4705ET1G	CJ6	17.10	18	18.90	50	0.05	13.6	
MMSZ4709ET1G	CK1	22.80	24	25.20	50	0.01	18.2	
MMSZ4711ET1G	СКЗ	25.65	27	28.35	50	0.01	20.4	
MMSZ4717ET1G	CK9	40.85	43	45.15	50	0.01	32.6	

1. Nominal Zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^{\circ}C \pm 1^{\circ}C$ . \*Include SZ-prefix devices where applicable.

### MMSZ4xxxET1G Series, SZMMSZ4xxxET1G Series

#### **TYPICAL CHARACTERISTICS**





### MMSZ4xxxET1G Series, SZMMSZ4xxxET1G Series

#### 1000 1000 R, LEAKAGE CURRENT (µA) TA 25 С 0 V BIAS 100 C, CAPACITANCE (pF) 1 V BIAS 10 100 1 +150°C BIAS AT 0.1 50% OF V<sub>Z</sub> NOM 0.01 10 25°C 0.001 55°C 0.0001 1 0.00001 100 10 60 90 10 0 20 30 40 50 70 80 1 VZ, NOMINAL ZENER VOLTAGE (V) VZ, NOMINAL ZENER VOLTAGE (V) Figure 7. Typical Capacitance Figure 8. Typical Leakage Current 100 100 $T_A = 25^{\circ}C$ $T_A = 25^{\circ}C$ ZENER CURRENT (mA) ZENER CURRENT (mA) 10 10 1 1 0.01 0.01 ō 12 30 70 90 2 4 6 8 10 10 50 V<sub>Z</sub>, ZENER VOLTAGE (V) V<sub>7</sub>, ZENER VOLTAGE (V) Figure 9. Zener Voltage versus Zener Current Figure 10. Zener Voltage versus Zener Current (12 V to 91 V) (V<sub>Z</sub> Up to 12 V) 100 PEAK VALUE I\_{RSM} @ 8 $\mu s$ 90 **OF PEAK PULSE CURRENT** PULSE WIDTH (tp) IS DEFINED 80 AS THAT POINT WHERE THE 70 PEAK CURRENT DECAY = 8 µs

#### **TYPICAL CHARACTERISTICS**

t, TIME (μs) Figure 11. 8  $\times$  20  $\mu s$  Pulse Waveform

40

HALF VALUE I<sub>RSM</sub>/2 @ 20 μs

60

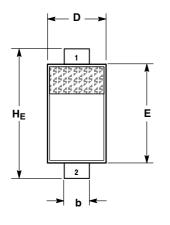
80

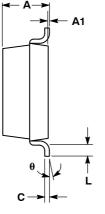
20

60 50

#### PACKAGE DIMENSIONS

**SOD-123** CASE 425-04 ISSUE G





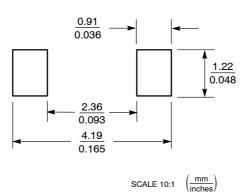
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982

2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
C			0.15			0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
E	2.54	2.69	2.84	0.100	0.106	0.112
HE	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25			0.010		
θ	0°		10°	0°		10°

PIN 1. CATHODE 2. ANODE

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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